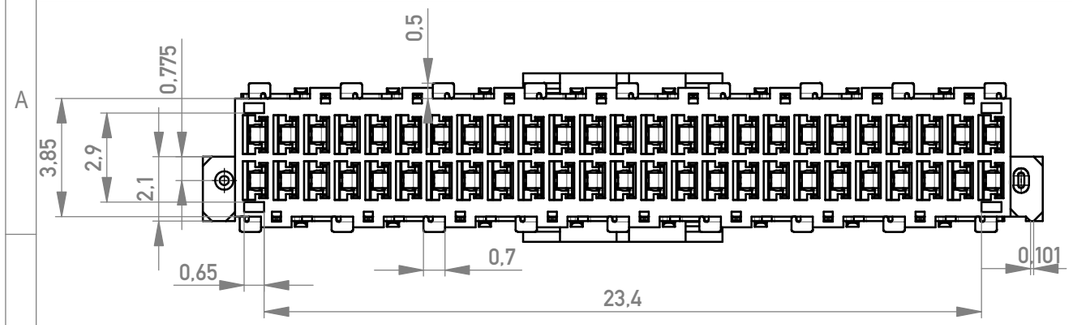
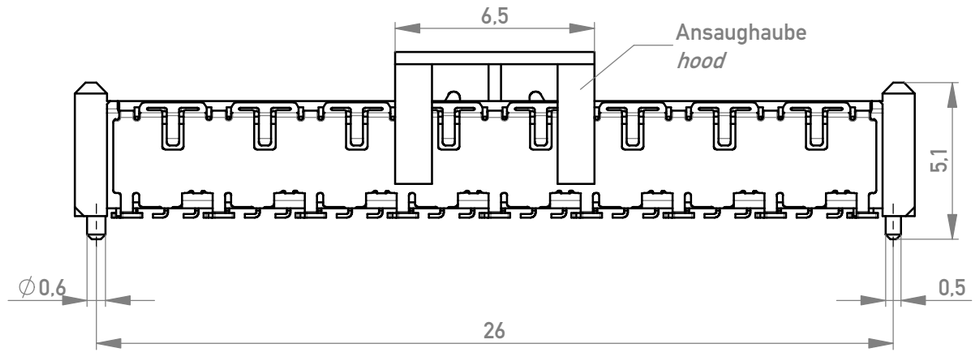
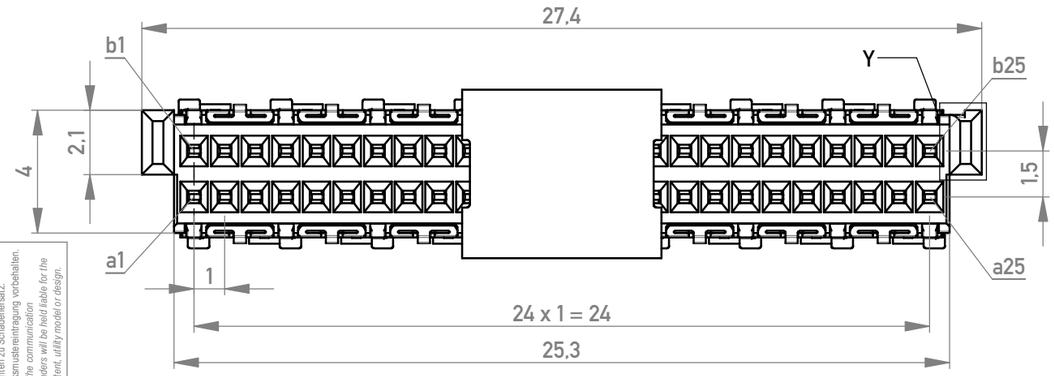
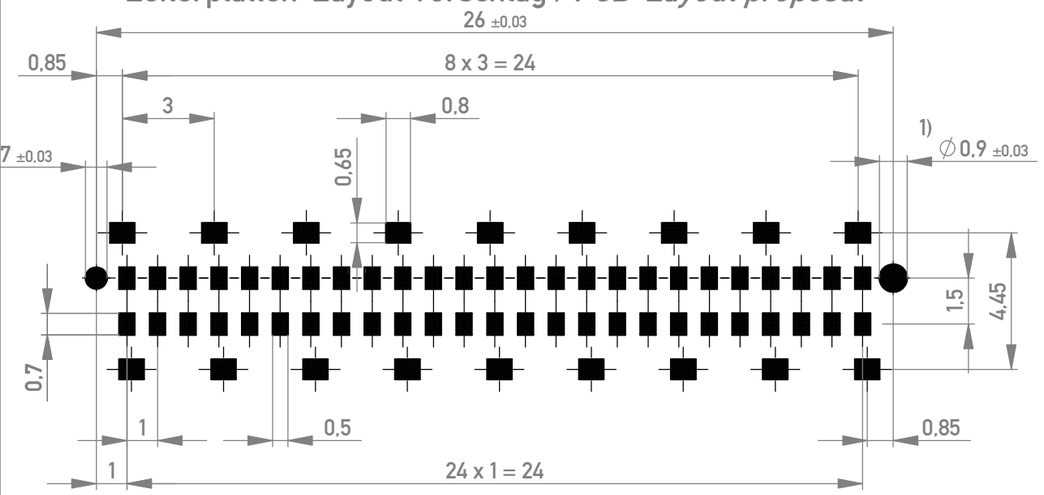


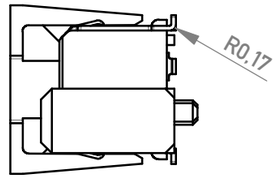


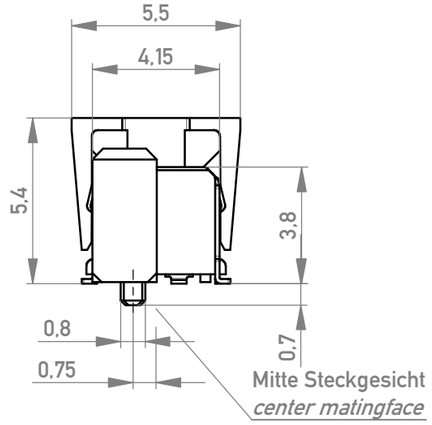


Leiterplatten-Layout Vorschlag / *PCB-Layout proposal*

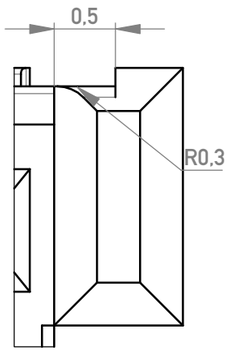


1) Durchmesser des Bohrers / *Drill tool*



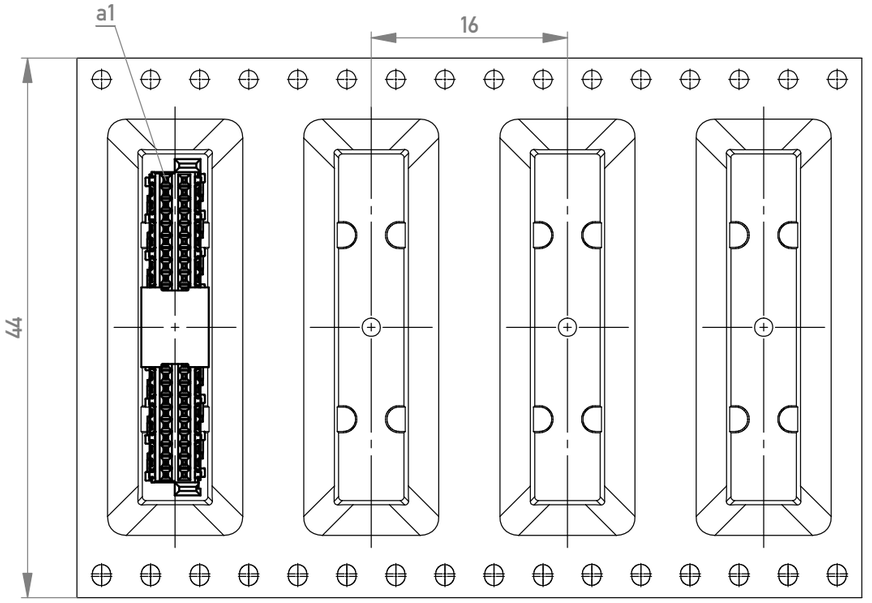


Einzelheit Y
M 20:1



Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 400 Stück
Packaging unit: 400 pcs

Abspulrichtung - *Reel off Direction*



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinnt 4-6µm
Terminal Area 4-6µm tin plating

Koplanarität der Anschlüsse ≤ 0,1mm
Coplanarity Area of Termination ≤ 0,1mm

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Die deutsche Version dieser Zeichnung dient nur zur Erleichterung der Handhabung. Bei Abweichungen von dem englischen Original gilt das englische Original.
The german version of this drawing has been offered for convenience only and may deviate from the english original. In case of any deviation the English version shall prevail.

Dimension no.	Tolerances ISO 8015	All Dimensions in mm	Scale 5:1
			Material
Customer drawing: This Drawing is a controlled Document.	Subject to modification without prior notice. Drawing will not be updated.		F04 MSpeed BlindMate 50 SMD
d1 / Index	18.05.2023 / Date	TE Connectivity	C-254876-E CR A3
			Class MSPEED